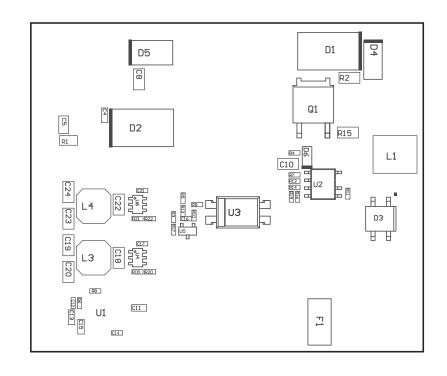


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

| PCB VIEWED FROM TOP SIDE | BOARD #: PMP9661 | REV: A | SUN REU | : Not In VersionControl |
|----------------------------------|--------------------|---------------|---------|-------------------------|
| IGNORE -> Top Overlay | | | | |
| PLOT NAME = Top Assembly Drawing | GENERATED : 4/3/20 | 014 2: 27: 53 | PM | TEXAS INSTRUMENTS |



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

| PCB VIEWED FROM BOTTOM SIDE | BOARD #: PMP9661 | REV: A | SUN REV: Not In VersionControl | |
|-------------------------------------|--------------------------|-------------|--------------------------------|-------------------|
| | Bottom Overlay <- 390001 | | | |
| PLOT NAME = Bottom Assembly Drawing | GENERATED : 4/3/20 | 014 2:27:54 | PM | TEXAS INSTRUMENTS |

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